

[illegible]

My residence, post office address and citizenship are as stated below next to my name.

X is attached hereto.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims.

I hereby claim the benefit of any earlier filing date in the United States to which I am entitled under Title 35 of the United States Code, § 120 and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35 of the United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37 of the Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Status)

Paul A. Revis
Micron Electronics, Inc..
900 East Karcher Road
Nampa, ID 83687
(208) 898-1316

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's Signature:

Date:

Residence Address:

City, State, Country:

Nampa, ID 83651 United States of America

U.S.

Same as residence address

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: R. Doug Smith

Serial No.: Unknown

Filed: Concurrently Herewith

For: Apparatus For Securing A Component In
A Computer Chassis

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Atty. Docket: 00.03315

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DATE OF DEPOSIT 12-1-00
I HEREBY CERTIFY THAT THIS PAPER IS BEING DEPOSITED
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ASSISTANT COMMISSIONER FOR PATENTS, WASHINGTON, D.C.
20231.

Nancy Hammond
Signature

ELECTION UNDER 37 C.F.R. §§ 3.71 AND 3.73 AND POWER OF ATTORNEY

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

The undersigned, being Assignee of the entire interest in the above-identified application by virtue of an Assignment recorded in the United States Patent and Trademark Office as set forth below or filed herewith, hereby elects, under 37 C.F.R. § 3.71, to prosecute the application to the exclusion of the inventor(s).

The Assignee hereby revokes any previous Powers of Attorney and appoints: Hoyt A. Fleming, III, Reg No. 41,752; Steven P. Arnold, Reg No., 33,354 as its attorney or agent, with full power of substitution and revocation, to prosecute the application, to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, to receive any Letters Patent, and for one year after issuance of such Letters Patent to file any request for a certificate of correction that may be deemed appropriate.

Pursuant to 37 C.F.R. § 3.73, the undersigned duly authorized designee of Assignee certifies that the evidentiary documents have been reviewed, specifically the Assignment to MICRON ELECTRONICS, INC., referenced below, and certifies that to the best of my knowledge and belief, title remains in the name of the Assignee.

Assignment:

☒ Filed concurrently herewith for
recording, a copy of which is
attached hereto.

Previously recorded on: _____,
at Reel: _____ Frame: _____.

Date: 12/1/00

Please direct all communications as follows:

Paul A. Revis
MICRON ELECTRONICS, INC.
900 East Karcher Road
Nampa, ID 83687
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ASSIGNEE: MICRON ELECTRONICS, INC.

By: Paul A. Revis
Paul A. Revis, Reg No.: 45,040
Intellectual Property Counsel

00720405-120400